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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

Product Status	Obsolete
Number of LABs/CLBs	3537
Number of Logic Elements/Cells	75000
Total RAM Bits	8666112
Number of I/O	336
Number of Gates	-
Voltage - Supply	1.07V ~ 1.13V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BBGA, FCBGA
Supplier Device Package	672-FBGA (27x27)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/intel/5agxba1d4f27c4n">https://www.e-xfl.com/product-detail/intel/5agxba1d4f27c4n</a>

Symbol	Description	Condition	Minimum <sup>(1)</sup>	Typical	Maximum <sup>(1)</sup>	Unit
$V_{CC}$	Core voltage power supply	–C4, –I5, –C5, –C6	1.07	1.1	1.13	V
		–I3	1.12	1.15	1.18	V
$V_{CCP}$	Periphery circuitry, PCIe hard IP block, and transceiver PCS power supply	–C4, –I5, –C5, –C6	1.07	1.1	1.13	V
		–I3	1.12	1.15	1.18	V
$V_{CCPGM}$	Configuration pins power supply	3.3 V	3.135	3.3	3.465	V
		3.0 V	2.85	3.0	3.15	V
		2.5 V	2.375	2.5	2.625	V
		1.8 V	1.71	1.8	1.89	V
$V_{CC\_AUX}$	Auxiliary supply	—	2.375	2.5	2.625	V
$V_{CCBAT}^{(2)}$	Battery back-up power supply (For design security volatile key register)	—	1.2	—	3.0	V
$V_{CCPD}^{(3)}$	I/O pre-driver power supply	3.3 V	3.135	3.3	3.465	V
		3.0 V	2.85	3.0	3.15	V
		2.5 V	2.375	2.5	2.625	V

<sup>(1)</sup> The power supply value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

<sup>(2)</sup> If you do not use the design security feature in Arria V devices, connect  $V_{CCBAT}$  to a 1.5-V, 2.5-V, or 3.0-V power supply. Arria V power-on reset (POR) circuitry monitors  $V_{CCBAT}$ . Arria V devices do not exit POR if  $V_{CCBAT}$  is not powered up.

<sup>(3)</sup>  $V_{CCPD}$  must be 2.5 V when  $V_{CCIO}$  is 2.5, 1.8, 1.5, 1.35, 1.25, or 1.2 V.  $V_{CCPD}$  must be 3.0 V when  $V_{CCIO}$  is 3.0 V.  $V_{CCPD}$  must be 3.3 V when  $V_{CCIO}$  is 3.3 V.

## Transceiver Power Supply Operating Conditions

Table 1-4: Transceiver Power Supply Operating Conditions for Arria V Devices

Symbol	Description	Minimum <sup>(5)</sup>	Typical	Maximum <sup>(5)</sup>	Unit
V <sub>CCA_GXBL</sub>	Transceiver high voltage power (left side)	2.375	2.500	2.625	V
V <sub>CCA_GXBR</sub>	Transceiver high voltage power (right side)				
V <sub>CCR_GXBL</sub>	GX and SX speed grades—receiver power (left side)	1.08/1.12	1.1/1.15 <sup>(6)</sup>	1.14/1.18	V
V <sub>CCR_GXBR</sub>	GX and SX speed grades—receiver power (right side)				
V <sub>CCR_GXBL</sub>	GT and ST speed grades—receiver power (left side)	1.17	1.20	1.23	V
V <sub>CCR_GXBR</sub>	GT and ST speed grades—receiver power (right side)				
V <sub>CCT_GXBL</sub>	GX and SX speed grades—transmitter power (left side)	1.08/1.12	1.1/1.15 <sup>(6)</sup>	1.14/1.18	V
V <sub>CCT_GXBR</sub>	GX and SX speed grades—transmitter power (right side)				
V <sub>CCT_GXBL</sub>	GT and ST speed grades—transmitter power (left side)	1.17	1.20	1.23	V
V <sub>CCT_GXBR</sub>	GT and ST speed grades—transmitter power (right side)				
V <sub>CCH_GXBL</sub>	Transmitter output buffer power (left side)	1.425	1.500	1.575	V
V <sub>CCH_GXBR</sub>	Transmitter output buffer power (right side)				

<sup>(5)</sup> The power supply value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

<sup>(6)</sup> For data rate ≤ 3.2 Gbps, connect V<sub>CCR\_GXBL/R</sub>, V<sub>CCT\_GXBL/R</sub>, or V<sub>CCL\_GXBL/R</sub> to either 1.1-V or 1.15-V power supply. For data rate > 3.2 Gbps, connect V<sub>CCR\_GXBL/R</sub>, V<sub>CCT\_GXBL/R</sub>, or V<sub>CCL\_GXBL/R</sub> to a 1.15-V power supply. For details, refer to the Arria V GT, GX, ST, and SX Device Family Pin Connection Guidelines.

I/O Standard	$V_{CCIO}$ (V)			$V_{ID}$ (mV) <sup>(16)</sup>			$V_{ICM(DC)}$ (V)			$V_{OD}$ (V) <sup>(17)</sup>			$V_{OCM}$ (V) <sup>(17)(18)</sup>		
	Min	Typ	Max	Min	Condition	Max	Min	Condition	Max	Min	Typ	Max	Min	Typ	Max
PCML	Transmitter, receiver, and input reference clock pins of high-speed transceivers use the PCML I/O standard. For transmitter, receiver, and reference clock I/O pin specifications, refer to Transceiver Specifications for Arria V GX and SX Devices and Transceiver Specifications for Arria V GT and ST Devices tables.														
2.5 V LVDS <sup>(19)</sup>	2.375	2.5	2.625	100	$V_{CM} = 1.25$ V	—	0.05	$D_{MAX} \leq 1.25$ Gbps	1.80	0.247	—	0.6	1.125	1.25	1.375
						—	1.05	$D_{MAX} > 1.25$ Gbps	1.55						
RSDS (HIO) <sup>(20)</sup>	2.375	2.5	2.625	100	$V_{CM} = 1.25$ V	—	0.25	—	1.45	0.1	0.2	0.6	0.5	1.2	1.4
Mini-LVDS (HIO) <sup>(21)</sup>	2.375	2.5	2.625	200	—	600	0.300	—	1.425	0.25	—	0.6	1	1.2	1.4
LVPECL <sup>(22)</sup>	—	—	—	300	—	—	0.60	$D_{MAX} \leq 700$ Mbps	1.80	—	—	—	—	—	—
							1.00	$D_{MAX} > 700$ Mbps	1.60						

**Related Information**

- [Transceiver Specifications for Arria V GX and SX Devices](#) on page 1-23  
Provides the specifications for transmitter, receiver, and reference clock I/O pin.

<sup>(16)</sup> The minimum  $V_{ID}$  value is applicable over the entire common mode range,  $V_{CM}$ .

<sup>(17)</sup>  $R_L$  range:  $90 \leq R_L \leq 110 \Omega$ .

<sup>(18)</sup> This applies to default pre-emphasis setting only.

<sup>(19)</sup> For optimized LVDS receiver performance, the receiver voltage input range must be within 1.0 V to 1.6 V for data rates above 1.25 Gbps and 0 V to 1.85 V for data rates below 1.25 Gbps.

<sup>(20)</sup> For optimized RSDS receiver performance, the receiver voltage input range must be within 0.25 V to 1.45 V.

<sup>(21)</sup> For optimized Mini-LVDS receiver performance, the receiver voltage input range must be within 0.3 V to 1.425 V.

<sup>(22)</sup> For optimized LVPECL receiver performance, the receiver voltage input range must be within 0.85 V to 1.75 V for data rates above 700 Mbps and 0.45 V to 1.95 V for data rates below 700 Mbps.

Quartus Prime 1st Post Tap Pre-Emphasis Setting	Quartus Prime V <sub>OD</sub> Setting							Unit
	10 (200 mV)	20 (400 mV)	30 (600 mV)	35 (700 mV)	40 (800 mV)	45 (900 mV)	50 (1000 mV)	
16	—	—	9.56	7.73	6.49	—	—	dB
17	—	—	10.43	8.39	7.02	—	—	dB
18	—	—	11.23	9.03	7.52	—	—	dB
19	—	—	12.18	9.7	8.02	—	—	dB
20	—	—	13.17	10.34	8.59	—	—	dB
21	—	—	14.2	11.1	—	—	—	dB
22	—	—	15.38	11.87	—	—	—	dB
23	—	—	—	12.67	—	—	—	dB
24	—	—	—	13.48	—	—	—	dB
25	—	—	—	14.37	—	—	—	dB
26	—	—	—	—	—	—	—	dB
27	—	—	—	—	—	—	—	dB
28	—	—	—	—	—	—	—	dB
29	—	—	—	—	—	—	—	dB
30	—	—	—	—	—	—	—	dB
31	—	—	—	—	—	—	—	dB

**Related Information****[SPICE Models for Altera Devices](#)**

Provides the Arria V HSSI HSPICE models.

**Transceiver Compliance Specification**

The following table lists the physical medium attachment (PMA) specification compliance of all supported protocol for Arria V GX, GT, SX, and ST devices. For more information about the protocol parameter details and compliance specifications, contact your Altera Sales Representative.

## Memory Output Clock Jitter Specifications

**Table 1-45: Memory Output Clock Jitter Specifications for Arria V Devices**

The memory output clock jitter measurements are for 200 consecutive clock cycles, as specified in the JEDEC DDR2/DDR3 SDRAM standard.

The memory output clock jitter is applicable when an input jitter of 30 ps (p-p) is applied with bit error rate (BER)  $10^{-12}$ , equivalent to 14 sigma.

Altera recommends using the UniPHY intellectual property (IP) with PHYCLK connections for better jitter performance.

Parameter	Clock Network	Symbol	-I3, -C4		-I5, -C5		-C6		Unit
			Min	Max	Min	Max	Min	Max	
Clock period jitter	PHYCLK	$t_{JIT(per)}$	-41	41	-50	50	-55	55	ps
Cycle-to-cycle period jitter	PHYCLK	$t_{JIT(cc)}$	63		90		94		ps

## OCT Calibration Block Specifications

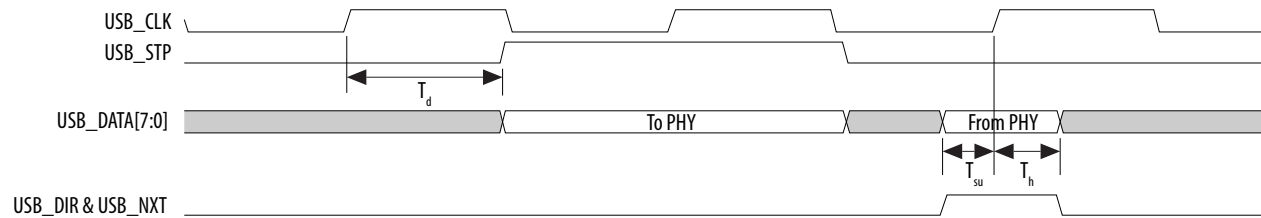
**Table 1-46: OCT Calibration Block Specifications for Arria V Devices**

Symbol	Description	Min	Typ	Max	Unit
OCTUSRCLK	Clock required by OCT calibration blocks	—	—	20	MHz
$T_{OCTCAL}$	Number of OCTUSRCLK clock cycles required for $R_S$ OCT/ $R_T$ OCT calibration	—	1000	—	Cycles
$T_{OCTSHIFT}$	Number of OCTUSRCLK clock cycles required for OCT code to shift out	—	32	—	Cycles
$T_{RS\_RT}$	Time required between the <code>dyn_term_ctrl</code> and <code>oe</code> signal transitions in a bidirectional I/O buffer to dynamically switch between $R_S$ OCT and $R_T$ OCT	—	2.5	—	ns

Symbol	Description	Min	Max	Unit
$T_h$	SPI MISO hold time	1	—	ns
$T_{\text{duty cycle}}$	SPI_CLK duty cycle	45	55	%
$T_{\text{dssfrst}}$	Output delay SPI_SS valid before first clock edge	8	—	ns
$T_{\text{dsslst}}$	Output delay SPI_SS valid after last clock edge	8	—	ns
$T_{\text{dio}}$	Master-out slave-in (MOSI) output delay	–1	1	ns

<sup>(86)</sup> This value is based on  $\text{rx\_sample\_dly} = 1$  and  $\text{spi\_m\_clk} = 120$  MHz.  $\text{spi\_m\_clk}$  is the internal clock that is used by SPI Master to derive its  $\text{SCLK\_OUT}$ . These timings are based on  $\text{rx\_sample\_dly}$  of 1. This delay can be adjusted as needed to accommodate slower response times from the slave. Note that a delay of 0 is not allowed. The setup time can be used as a reference starting point. It is very crucial to do a calibration to get the correct  $\text{rx\_sample\_dly}$  value because each SPI slave device may have different output delay and each application board may have different path delay. For more information about  $\text{rx\_sample\_delay}$ , refer to the SPI Controller chapter in the Hard Processor System Technical Reference Manual.

Figure 1-12: USB Timing Diagram



Ethernet Media Access Controller (EMAC) Timing Characteristics

Table 1-56: Reduced Gigabit Media Independent Interface (RGMII) TX Timing Requirements for Arria V Devices

Symbol	Description	Min	Typ	Max	Unit
$T_{clk}$ (1000Base-T)	TX_CLK clock period	—	8	—	ns
$T_{clk}$ (100Base-T)	TX_CLK clock period	—	40	—	ns
$T_{clk}$ (10Base-T)	TX_CLK clock period	—	400	—	ns
$T_{duty cycle}$	TX_CLK duty cycle	45	—	55	%
$T_d$	TX_CLK to TXD/TX_CTL output data delay	-0.85	—	0.15	ns

Figure 1-13: RGMII TX Timing Diagram

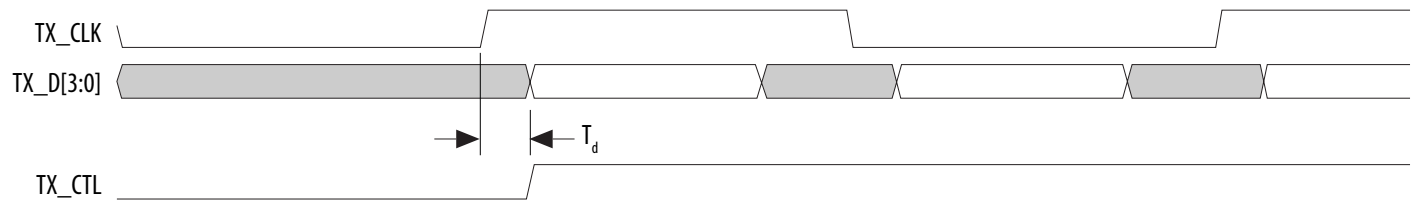
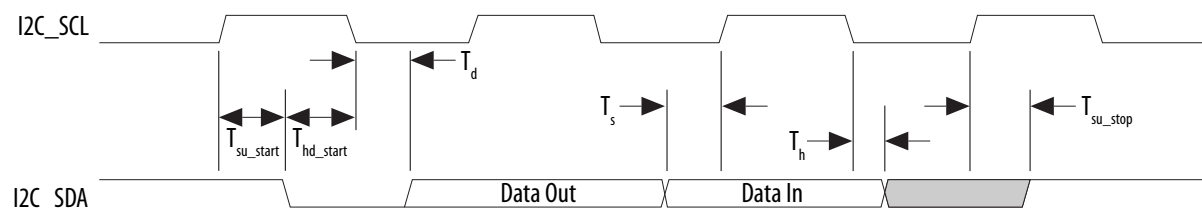




Figure 1-16: I<sup>2</sup>C Timing Diagram

## NAND Timing Characteristics

Table 1-60: NAND ONFI 1.0 Timing Requirements for Arria V Devices

The NAND controller supports Open NAND FLASH Interface (ONFI) 1.0 Mode 5 timing as well as legacy NAND devices. This table lists the requirements for ONFI 1.0 mode 5 timing. The HPS NAND controller can meet this timing by programming the c4 output of the main HPS PLL and timing registers provided in the NAND controller.

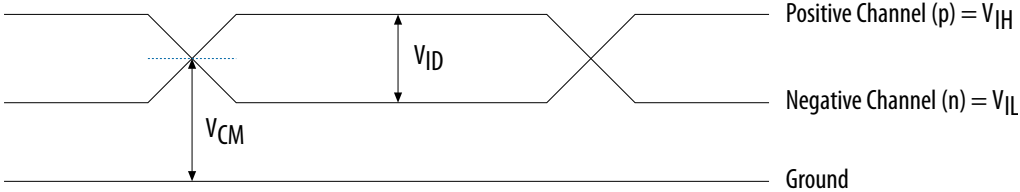
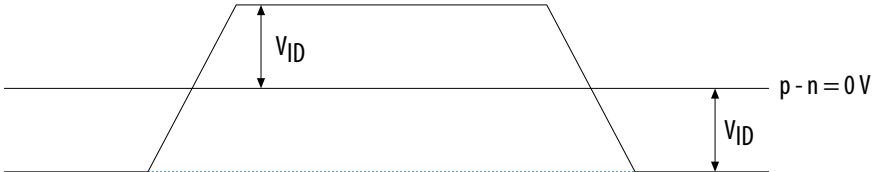
Symbol	Description	Min	Max	Unit
$T_{wp}^{(89)}$	Write enable pulse width	10	—	ns
$T_{wh}^{(89)}$	Write enable hold time	7	—	ns
$T_{rp}^{(89)}$	Read enable pulse width	10	—	ns
$T_{reh}^{(89)}$	Read enable hold time	7	—	ns
$T_{clesu}^{(89)}$	Command latch enable to write enable setup time	10	—	ns
$T_{cleh}^{(89)}$	Command latch enable to write enable hold time	5	—	ns
$T_{cesu}^{(89)}$	Chip enable to write enable setup time	15	—	ns
$T_{ceh}^{(89)}$	Chip enable to write enable hold time	5	—	ns
$T_{alesu}^{(89)}$	Address latch enable to write enable setup time	10	—	ns
$T_{aleh}^{(89)}$	Address latch enable to write enable hold time	5	—	ns
$T_{dsu}^{(89)}$	Data to write enable setup time	10	—	ns

<sup>(89)</sup> Timing of the NAND interface is controlled through the NAND configuration registers.

Symbol	Parameter	Typical	Unit
$D_{\text{OUTBUF}}$	Rising and/or falling edge delay	0 (default)	ps
		50	ps
		100	ps
		150	ps

## Glossary

Table 1-78: Glossary

Term	Definition
Differential I/O standards	<p>Receiver Input Waveforms</p> <p><b>Single-Ended Waveform</b></p>  <p>Positive Channel (p) = <math>V_{IH}</math></p> <p>Negative Channel (n) = <math>V_{IL}</math></p> <p>Ground</p> <p><b>Differential Waveform</b></p>  <p><math>p - n = 0V</math></p>

The maximum allowed overshoot duration is specified as a percentage of high time over the lifetime of the device. A DC signal is equivalent to 100% of the duty cycle.

For example, a signal that overshoots to 3.95 V can be at 3.95 V for only ~21% over the lifetime of the device; for a device lifetime of 10 years, the overshoot duration amounts to ~2 years.

**Table 2-4: Maximum Allowed Overshoot During Transitions for Arria V GZ Devices**

Symbol	Description	Condition (V)	Overshoot Duration as % @ $T_J = 100^\circ\text{C}$	Unit
Vi (AC)	AC input voltage	3.8	100	%
		3.85	64	%
		3.9	36	%
		3.95	21	%
		4	12	%
		4.05	7	%
		4.1	4	%
		4.15	2	%
		4.2	1	%

## Recommended Operating Conditions

**Table 2-5: Recommended Operating Conditions for Arria V GZ Devices**

Power supply ramps must all be strictly monotonic, without plateaus.

Symbol	Description	Condition	Minimum <sup>(114)</sup>	Typical	Maximum <sup>(114)</sup>	Unit
V <sub>CC</sub>	Core voltage and periphery circuitry power supply <sup>(115)</sup>	—	0.82	0.85	0.88	V

<sup>(114)</sup> The power supply value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

<sup>(115)</sup> The V<sub>CC</sub> core supply must be set to 0.9 V if the Partial Reconfiguration (PR) feature is used.

Symbol	Description	Condition	Minimum <sup>(114)</sup>	Typical	Maximum <sup>(114)</sup>	Unit
V <sub>I</sub>	DC input voltage	—	−0.5	—	3.6	V
V <sub>O</sub>	Output voltage	—	0	—	V <sub>CCIO</sub>	V
T <sub>J</sub>	Operating junction temperature	Commercial	0	—	85	°C
		Industrial	−40	—	100	°C
t <sub>RAMP</sub>	Power supply ramp time	Standard POR	200 μs	—	100 ms	—
		Fast POR	200 μs	—	4 ms	—

### Recommended Transceiver Power Supply Operating Conditions

**Table 2-6: Recommended Transceiver Power Supply Operating Conditions for Arria V GZ Devices**

Symbol	Description	Minimum <sup>(118)</sup>	Typical	Maximum <sup>(118)</sup>	Unit
V <sub>CCA_GXBL</sub> (119), (120)	Transceiver channel PLL power supply (left side)	2.85	3.0	3.15	V
		2.375	2.5	2.625	
V <sub>CCA_GXBR</sub> (119), (120)	Transceiver channel PLL power supply (right side)	2.85	3.0	3.15	V
		2.375	2.5	2.625	
V <sub>CCHIP_L</sub>	Transceiver hard IP power supply (left side)	0.82	0.85	0.88	V
V <sub>CCHSSL_L</sub>	Transceiver PCS power supply (left side)	0.82	0.85	0.88	V
V <sub>CCHSSL_R</sub>	Transceiver PCS power supply (right side)	0.82	0.85	0.88	V

<sup>(114)</sup> The power supply value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

<sup>(118)</sup> This value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

<sup>(119)</sup> This supply must be connected to 3.0 V if the CMU PLL, receiver CDR, or both, are configured at a base data rate > 6.5 Gbps. Up to 6.5 Gbps, you can connect this supply to either 3.0 V or 2.5 V.

<sup>(120)</sup> When using ATX PLLs, the supply must be 3.0 V.

Symbol/Description	Conditions	Transceiver Speed Grade 2			Transceiver Speed Grade 3			Unit
		Min	Typ	Max	Min	Typ	Max	
Differential on-chip termination resistors	85- $\Omega$ setting	—	85 $\pm$ 20%	—	—	85 $\pm$ 20%	—	$\Omega$
	100- $\Omega$ setting	—	100 $\pm$ 20%	—	—	100 $\pm$ 20%	—	$\Omega$
	120- $\Omega$ setting	—	120 $\pm$ 20%	—	—	120 $\pm$ 20%	—	$\Omega$
	150- $\Omega$ setting	—	150 $\pm$ 20%	—	—	150 $\pm$ 20%	—	$\Omega$
V <sub>OCM</sub> (AC coupled)	0.65-V setting	—	650	—	—	650	—	mV
V <sub>OCM</sub> (DC coupled)	—	—	650	—	—	650	—	mV
Intra-differential pair skew	Tx V <sub>CM</sub> = 0.5 V and slew rate of 15 ps	—	—	15	—	—	15	ps
Intra-transceiver block transmitter channel-to-channel skew	x6 PMA bonded mode	—	—	120	—	—	120	ps
Inter-transceiver block transmitter channel-to-channel skew	xN PMA bonded mode	—	—	500	—	—	500	ps

**Related Information****[Arria V Device Overview](#)**

For more information about device ordering codes.

Symbol/Description	Conditions	Transceiver Speed Grade 2			Transceiver Speed Grade 3			Unit
		Min	Typ	Max	Min	Typ	Max	
Supported data range	—	600	—	3250/ 3125 <sup>(158)</sup>	600	—	3250/ 3125 <sup>(158)</sup>	Mbps
$t_{\text{pll\_powerdown}}$ <sup>(159)</sup>	—	1	—	—	1	—	—	μs
$t_{\text{pll\_lock}}$ <sup>(160)</sup>	—	—	—	10	—	—	10	μs

**Related Information**[Arria V Device Overview](#)

For more information about device ordering codes.

**Clock Network Data Rate****Table 2-29: Clock Network Maximum Data Rate Transmitter Specifications**

Valid data rates below the maximum specified in this table depend on the reference clock frequency and the PLL counter settings. Check the MegaWizard message during the PHY IP instantiation.

Clock Network	ATX PLL			CMU PLL <sup>(161)</sup>			fPLL		
	Non-bonded Mode (Gbps)	Bonded Mode (Gbps)	Channel Span	Non-bonded Mode (Gbps)	Bonded Mode (Gbps)	Channel Span	Non-bonded Mode (Gbps)	Bonded Mode (Gbps)	Channel Span
x1 <sup>(162)</sup>	12.5	—	6	12.5	—	6	3.125	—	3
x6 <sup>(162)</sup>	—	12.5	6	—	12.5	6	—	3.125	6
x6 PLL Feedback <sup>(163)</sup>	—	12.5	Side-wide	—	12.5	Side-wide	—	—	—

<sup>(158)</sup> When you use fPLL as a TXPLL of the transceiver.

<sup>(159)</sup>  $t_{\text{pll\_powerdown}}$  is the PLL powerdown minimum pulse width.

<sup>(160)</sup>  $t_{\text{pll\_lock}}$  is the time required for the transmitter CMU/ATX PLL to lock to the input reference clock frequency after coming out of reset.

<sup>(161)</sup> ATX PLL is recommended at 8 Gbps and above data rates for improved jitter performance.

<sup>(162)</sup> Channel span is within a transceiver bank.

<sup>(163)</sup> Side-wide channel bonding is allowed up to the maximum supported by the PHY IP.

Symbol	V <sub>OD</sub> Setting	V <sub>OD</sub> Value (mV)	V <sub>OD</sub> Setting	V <sub>OD</sub> Value (mV)
V <sub>OD</sub> differential peak to peak typical	15	300	47	940
	16	320	48	960
	17	340	49	980
	18	360	50	1000
	19	380	51	1020
	20	400	52	1040
	21	420	53	1060
	22	440	54	1080
	23	460	55	1100
	24	480	56	1120
	25	500	57	1140
	26	520	58	1160
	27	540	59	1180
	28	560	60	1200
	29	580	61	1220
	30	600	62	1240
	31	620	63	1260

## Core Performance Specifications

### Clock Tree Specifications

**Table 2-33: Clock Tree Performance for Arria V GZ Devices**

Symbol	Performance		Unit
	C3, I3L	C4, I4	
Global and Regional Clock	650	580	MHz
Periphery Clock	500	500	MHz

### PLL Specifications

**Table 2-34: PLL Specifications for Arria V GZ Devices**

Symbol	Parameter	Min	Typ	Max	Unit
$f_{IN}^{(167)}$	Input clock frequency (C3, I3L speed grade)	5	—	800	MHz
	Input clock frequency (C4, I4 speed grade)	5	—	650	MHz
$f_{INPFD}$	Input frequency to the PFD	5	—	325	MHz
$f_{FINPFD}$	Fractional Input clock frequency to the PFD	50	—	160	MHz
$f_{VCO}^{(168)}$	PLL VCO operating range (C3, I3L speed grade)	600	—	1600	MHz
	PLL VCO operating range (C4, I4 speed grade)	600	—	1300	MHz
$t_{EINDUTY}$	Input clock or external feedback clock input duty cycle	40	—	60	%

<sup>(167)</sup> This specification is limited in the Quartus II software by the I/O maximum frequency. The maximum I/O frequency is different for each I/O standard.

<sup>(168)</sup> The VCO frequency reported by the Quartus II software in the **PLL Usage Summary** section of the compilation report takes into consideration the VCO post-scale counter K value. Therefore, if the counter K has a value of 2, the frequency reported can be lower than the  $f_{VCO}$  specification.



Symbol	Conditions	C3, I3L			C4, I4			Unit
		Min	Typ	Max	Min	Typ	Max	
True Differential I/O Standards - $f_{\text{HSDR}}$ (data rate)	SERDES factor $J = 3$ to $10$ (182), (183)	(184)	—	1250	(184)	—	1050	Mbps
	SERDES factor $J \geq 4$ LVDS TX with DPA (185), (186), (187), (188)	(184)	—	1600	(184)	—	1250	Mbps
	SERDES factor $J = 2$ , uses DDR Registers	(184)	—	(189)	(184)	—	(189)	Mbps
	SERDES factor $J = 1$ , uses SDR Register	(184)	—	(189)	(184)	—	(189)	Mbps
Emulated Differential I/O Standards with Three External Output Resistor Networks - $f_{\text{HSDR}}$ (data rate) (190)	SERDES factor $J = 4$ to $10$ (191)	(184)	—	840	(184)	—	840	Mbps

(182) If the receiver with DPA enabled and transmitter are using shared PLLs, the minimum data rate is 150 Mbps.

(183) The  $F_{\text{MAX}}$  specification is based on the fast clock used for serial data. The interface  $F_{\text{MAX}}$  is also dependent on the parallel clock domain which is design dependent and requires timing analysis.

(184) The minimum specification depends on the clock source (for example, the PLL and clock pin) and the clock routing resource (global, regional, or local) that you use. The I/O differential buffer and input register do not have a minimum toggle rate.

(185) Arria V GZ RX LVDS will need DPA. For Arria V GZ TX LVDS, the receiver side component must have DPA.

(186) Requires package skew compensation with PCB trace length.

(187) Do not mix single-ended I/O buffer within LVDS I/O bank.

(188) Chip-to-chip communication only with a maximum load of 5 pF.

(189) The maximum ideal data rate is the SERDES factor ( $J$ ) x the PLL maximum output frequency ( $f_{\text{OUT}}$ ) provided you can close the design timing and the signal integrity simulation is clean.

(190) You must calculate the leftover timing margin in the receiver by performing link timing closure analysis. You must consider the board skew margin, transmitter channel-to-channel skew, and receiver sampling margin to determine leftover timing margin.

(191) When using True LVDS RX channels for emulated LVDS TX channel, only serialization factors 1 and 2 are supported.

**Table 2-55: DCLK-to-DATA[] Ratio for Arria V GZ Devices**

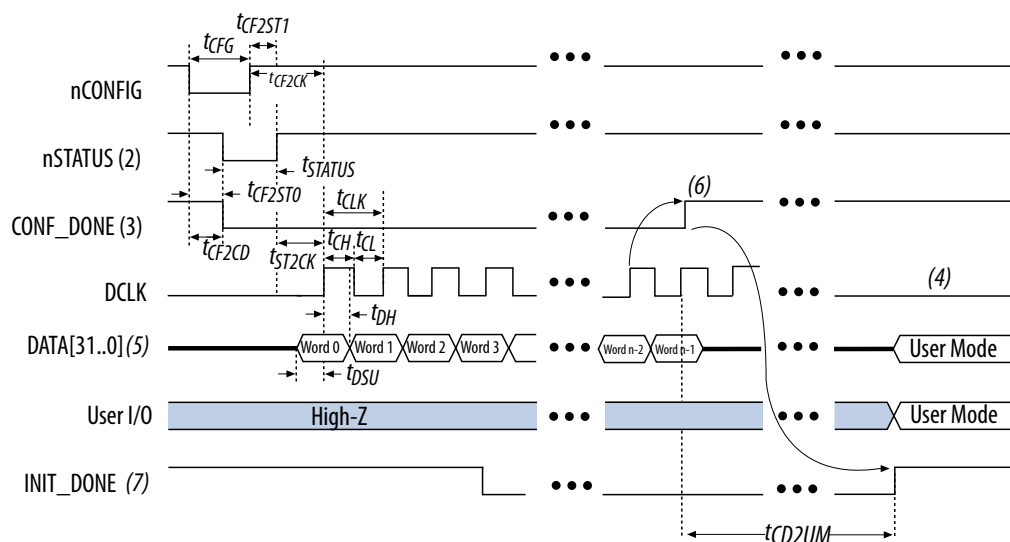
Depending on the DCLK-to-DATA[] ratio, the host must send a DCLK frequency that is  $r$  times the data rate in bytes per second (Bps), or words per second (Wps). For example, in FPP  $\times 16$  when the DCLK-to-DATA[] ratio is 2, the DCLK frequency must be 2 times the data rate in Wps. Arria V GZ devices use the additional clock cycles to decrypt and decompress the configuration data.

Configuration Scheme	Decompression	Design Security	DCLK-to-DATA[] Ratio
FPP $\times 8$	Disabled	Disabled	1
	Disabled	Enabled	1
	Enabled	Disabled	2
	Enabled	Enabled	2
FPP $\times 16$	Disabled	Disabled	1
	Disabled	Enabled	2
	Enabled	Disabled	4
	Enabled	Enabled	4
FPP $\times 32$	Disabled	Disabled	1
	Disabled	Enabled	4
	Enabled	Disabled	8
	Enabled	Enabled	8

## FPP Configuration Timing when DCLK to DATA[] = 1

Figure 2-7: FPP Configuration Timing Waveform When the DCLK-to-DATA[] Ratio is 1

Timing waveform for FPP configuration when using a MAX<sup>®</sup> II or MAX V device as an external host.



### Notes:

1. The beginning of this waveform shows the device in user mode. In user mode, nCONFIG, nSTATUS, and CONF\_DONE are at logic-high levels. When nCONFIG is pulled low, a reconfiguration cycle begins.
2. After power-up, the Arria V GZ device holds nSTATUS low for the time of the POR delay.
3. After power-up, before and during configuration, CONF\_DONE is low.
4. Do not leave DCLK floating after configuration. DCLK is ignored after configuration is complete. It can toggle high or low if required.
5. For FPP  $\times 16$ , use DATA[15..0]. For FPP  $\times 8$ , use DATA[7..0]. DATA[31..0] are available as a user I/O pin after configuration. The state of this pin depends on the dual-purpose pin settings.
6. To ensure a successful configuration, send the entire configuration data to the Arria V GZ device. CONF\_DONE is released high when the Arria V GZ device receives all the configuration data successfully. After CONF\_DONE goes high, send two additional falling edges on DCLK to begin initialization and enter user mode.
7. After the option bit to enable the INIT\_DONE pin is configured into the device, the INIT\_DONE goes low.

Table 2-62: Uncompressed .rbf Sizes for Arria V GZ Devices

Variant	Member Code	Configuration .rbf Size (bits)	IOCSR .rbf Size (bits) <sup>(223)</sup>
Arria V GZ	E1	137,598,880	562,208
	E3	137,598,880	562,208
	E5	213,798,880	561,760
	E7	213,798,880	561,760

Table 2-63: Minimum Configuration Time Estimation for Arria V GZ Devices

Variant	Member Code	Active Serial <sup>(224)</sup>			Fast Passive Parallel <sup>(225)</sup>		
		Width	DCLK (MHz)	Min Config Time (ms)	Width	DCLK (MHz)	Min Config Time (ms)
Arria V GZ	E1	4	100	344	32	100	43
	E3	4	100	344	32	100	43
	E5	4	100	534	32	100	67
	E7	4	100	534	32	100	67

## Remote System Upgrades Circuitry Timing Specification

Table 2-64: Remote System Upgrade Circuitry Timing Specifications

Parameter	Minimum	Maximum	Unit
$t_{RU\_nCONFIG}$ <sup>(226)</sup>	250	—	ns
$t_{RU\_nRSTIMER}$ <sup>(227)</sup>	250	—	ns

<sup>(223)</sup> The IOCSR .rbf size is specifically for the Configuration via Protocol (CvP) feature.

<sup>(224)</sup> DCLK frequency of 100 MHz using external CLKUSR.

<sup>(225)</sup> Max FPGA FPP bandwidth may exceed bandwidth available from some external storage or control logic.

Term	Definition
$t_C$	High-speed receiver and transmitter input and output clock period.
TCCS (channel-to-channel-skew)	The timing difference between the fastest and slowest output edges, including $t_{CO}$ variation and clock skew, across channels driven by the same PLL. The clock is included in the TCCS measurement (refer to the Timing Diagram figure under SW in this table).
$t_{DUTY}$	High-speed I/O block—Duty cycle on the high-speed transmitter output clock.
$t_{FALL}$	Signal high-to-low transition time (80-20%)
$t_{INCCJ}$	Cycle-to-cycle jitter tolerance on the PLL clock input.
$t_{OUTPJ\_IO}$	Period jitter on the general purpose I/O driven by a PLL.
$t_{OUTPJ\_DC}$	Period jitter on the dedicated clock output driven by a PLL.
$t_{RISE}$	Signal low-to-high transition time (20-80%)
Timing Unit Interval (TUI)	The timing budget allowed for skew, propagation delays, and the data sampling window. ( $TUI = 1/(\text{receiver input clock frequency multiplication factor}) = t_C/w$ )
$V_{CM(DC)}$	DC common mode input voltage.
$V_{ICM}$	Input common mode voltage—The common mode of the differential signal at the receiver.
$V_{ID}$	Input differential voltage swing—The difference in voltage between the positive and complementary conductors of a differential transmission at the receiver.
$V_{DIF(AC)}$	AC differential input voltage—Minimum AC input differential voltage required for switching.
$V_{DIF(DC)}$	DC differential input voltage— Minimum DC input differential voltage required for switching.
$V_{IH}$	Voltage input high—The minimum positive voltage applied to the input which is accepted by the device as a logic high.
$V_{IH(AC)}$	High-level AC input voltage
$V_{IH(DC)}$	High-level DC input voltage
$V_{IL}$	Voltage input low—The maximum positive voltage applied to the input which is accepted by the device as a logic low.
$V_{IL(AC)}$	Low-level AC input voltage
$V_{IL(DC)}$	Low-level DC input voltage